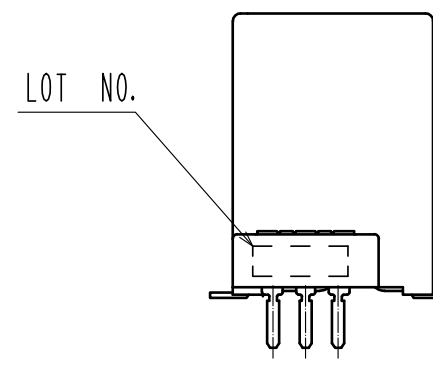
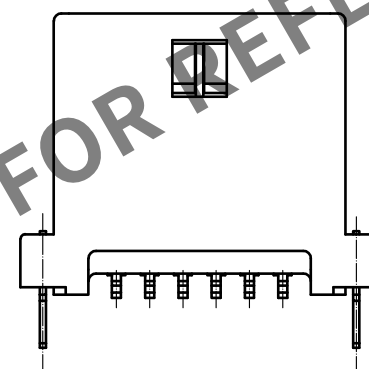
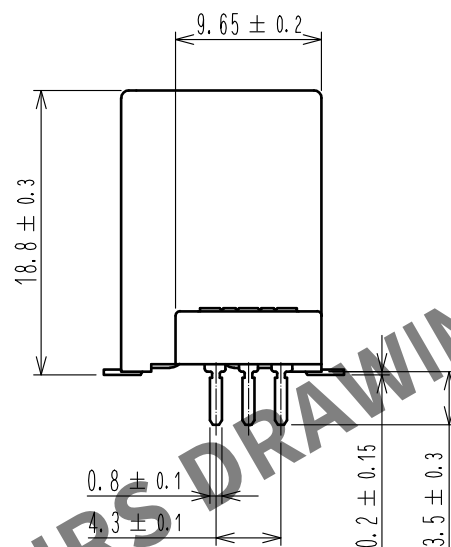
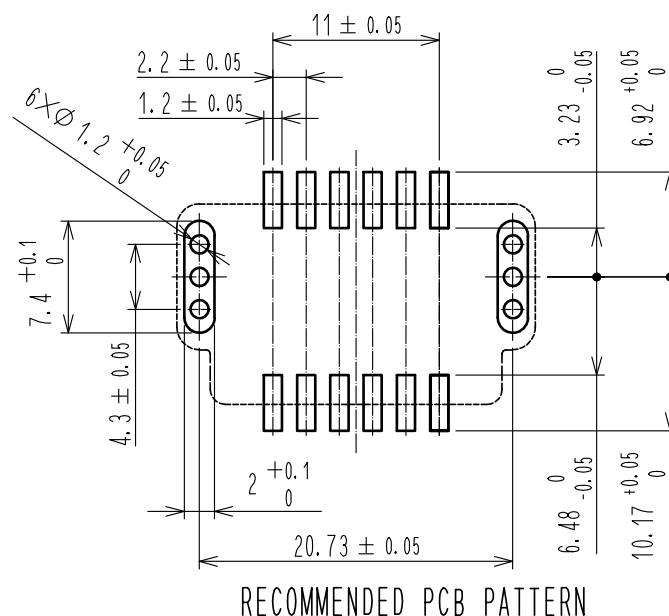
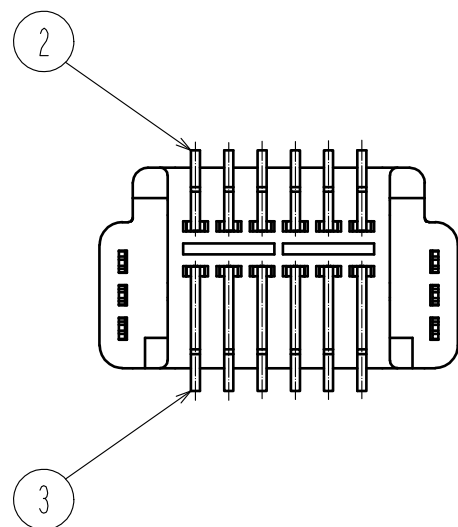
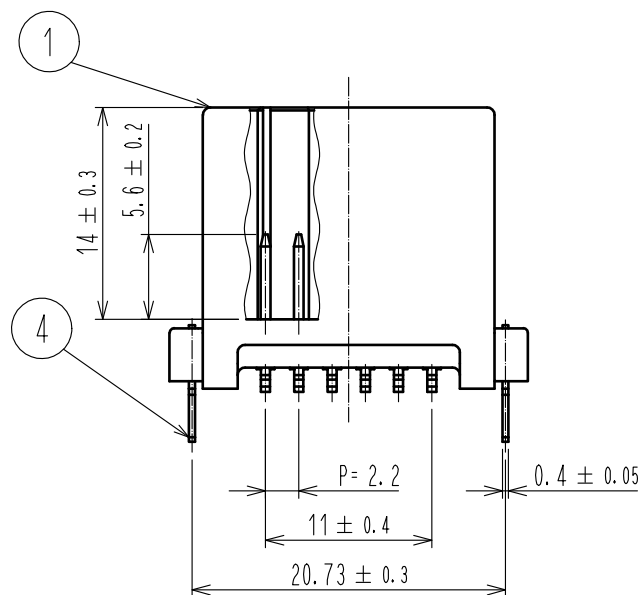
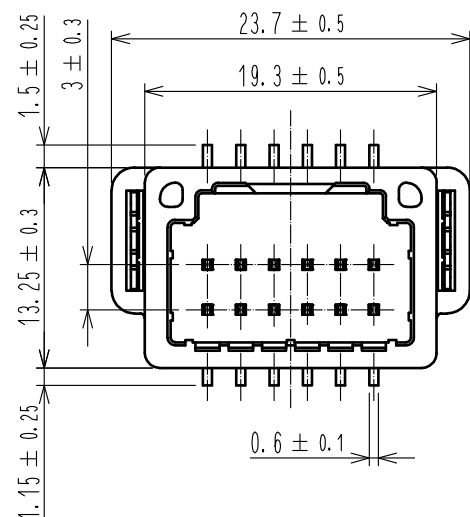
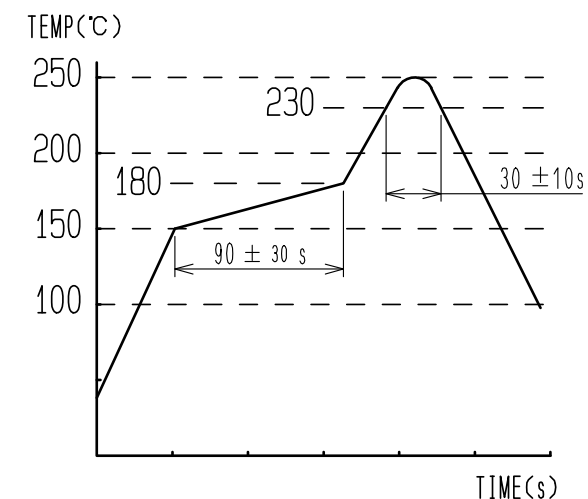


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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

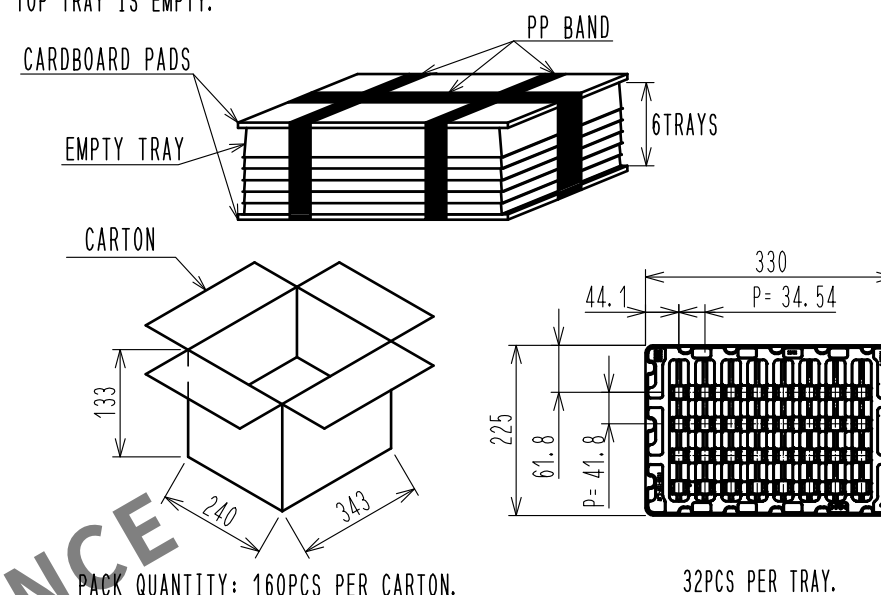
ELV, RoHS COMPLIANT

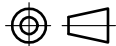


- NOTE 1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
USED REFLOW SYSTEM : IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C 60~120s
2. TEMPERATURE FOR SOLDERING IRON : 280~300°C WITHIN 2s
3. CO-PLANARITY SHALL BE 0.1mm MAX.
4. RECOMMENDED PCB THICKNESS IS 1.6mm.
5. RECOMMENDED SOLDER THICKNESS IS 0.15mm.



TRAY PACKING SPECIFICATIONS
6 TRAYS STACKING.
ODD NUMBER TRAYS AND EVEN NUMBER TRAYS ARE REVERSE DIRECTION.
TOP TRAY IS EMPTY.



2	BRASS	TIN PLATING T=0.64		4	BRASS	TIN PLATING T=0.4			
1	PPS	BLACK		3	BRASS	TIN PLATING T=0.64			
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS			
UNITS mm		SCALE		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE	
		2 : 1							
		APPROVED : HK. UMEHARA 20200928							
		DRAWING NO. EDC-169257-60-00							
		PART NO. GT25H-12DP-2.2V(60)							
 HIROSE ELECTRIC CO., LTD.		CHECKED : HH. TSUKUMO 20200927		PART NO.					
		DESIGNED : DONGCHAN KIM 20200924		CODE NO.					
		DRAWN : AN. SAIKI 20200917		CL775-0050-9-60					
									